

09-15-2003

Attorney Docket No.: 10844-35US (203070(D-2))



102550704

FORM COVER SHEET
PATENTS ONLY

Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Yoshiaki TANAKA

9.4.03

2. Name and address of receiving party(ies)

Uchihashi Estec Co., Ltd.
11-28, Shimanouchi 1-chome, Chuo-ku
Osaka-shi, Osaka
Japan

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other
- Correction of previously recorded document
Reel Frame No.

Execution Date: August 15, 2003

Additional name(s) & address(es) attached? Yes No

4. Application Number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: August 15, 2003

10656690

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

William W. Schwarze
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6. Total number of applications/patents involved: 1

7. Total fee (37 CFR 3.41).....\$40

- Check enclosed
- Authorization to charge deficient fees or credit any overpayment to Deposit Account.

8. Deposit Account Number: 50-1017

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William W. Schwarze
Name of Person Signing

William W. Schwarze
Signature

Sept. 4, 2003
Date

Total number of pages including cover sheet, attachments, and documents: 3

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ASSIGNMENT

WHEREAS, I, Yoshiaki TANAKA, a citizen of Japan with a post office address of c/o Uchihashi Estec Co., Ltd. of 11-28, Shimanouchi 1-chome, Chuo-ku, Osaka-shi, Osaka, Japan, hereinafter generally referred to as "ASSIGNOR", have invented a certain new and useful **Alloy Type Thermal Fuse and Material for a Thermal Fuse Element** for which I have executed a United States patent application, Application No. _____ filed, Herewith _____, 2002 and

ASSIGNOR authorizes ASSIGNEE or ASSIGNEE's representative to insert the Application Number and Filing date of this application if they are unknown at the time of execution of this Assignment.

WHEREAS, Uchihashi Estec Co., Ltd., a Japanese corporation having a place of business at 11-28, Shimanouchi 1-chome, Chuo-ku, Osaka-shi, Osaka, Japan hereinafter generally referred to as "ASSIGNEE", is desirous of acquiring said invention and said patent application.

NOW, THEREFORE, in consideration of the sum of One Dollar and other good and valuable executed consideration, the full receipt and sufficiency of all of which are hereby acknowledged, and intending to be legally bound hereby, I, the undersigned ASSIGNOR, hereby agree to sell, assign, transfer and convey and by these presents do sell, assign, transfer and convey unto the above-named ASSIGNEE, the whole and entire right, title and interest

in and to said invention as described in the above patent application, for the territory of the United States and its possessions and territories and all foreign countries;

in and to the above patent application and any and all related United States and foreign patent applications disclosing said invention, including provisionals, non-provisionals, divisions and continuations thereof, along with all rights of priority created by said patent application under any treaty relating thereto; and

in and to all United States and foreign patents which may be granted on any and all of said patent applications, including extensions, reissues and reexamination certificates thereof;